

MUN2141, MMUN2141L, MUN5141, DTA115TE, DTA115TM3, NSBA115TF3

Table 1. ORDERING INFORMATION

Device	Part Marking	Package	Shipping [†]
MMUN2141LT1G	ACH	SOT-23 (Pb-Free)	3000 / Tape & Reel
MUN5141T1G	6Т	SC-70/SOT-323 (Pb-Free)	3000 / Tape & Reel
DTA115TM3T5G	7G	SOT-723 (Pb-Free)	8000 / Tape & Reel
NSBA115TF3T5G	Q (90)*	SOT-1123 (Pb-Free)	8000 / Tape & Reel

DISCONTINUED (Note 1)

MUN2141T1G	6Y	SC–59 (Pb–Free)	3000 / Tape & Reel
DTA115TET1G	6U	SC–75 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

* (xx) = Degree rotation in the clockwise direction.

1. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

(1) SC-75 and SC-70/SOT323; Minimum Pad

(4) SOT-1123; 100 mm², 1 oz. copper trace

(2) SC-59; Minimum Pad

(3) SOT-23; Minimum Pad

(5) SOT-723; Minimum Pad

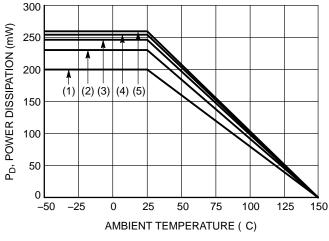


Figure 1. Derating Curve

MUN2141, MMUN2141L, MUN5141, DTA115TE, DTA115TM3, NSBA115TF3

Table 2. THERMAL CHARACTERISTICS

Characteristic Symbol Max Unit



SOT 23 (TO 236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

SOT 23 (TO 236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	I	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	PIN 1. CATHODE	
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	
	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT	STYLE 23: PIN 1. ANODE 2. ANODE 3. CATHODE 3.			



SC-70 (SOT-323) CASE 419 ISSUE R

DATE 11 OCT 2022

GENERIC MARKING DIAGRAM



ΧХ = Specific Device Code

М = Date Code •

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	STYLE 10:	STYLE 11:
PIN 1. EMITTER	PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	2. CATHODE
3. COLLECTOR	3. COLLECTOR	3. DRAIN	3. CATHODE-ANODE	3. ANODE-CATHODE	3. CATHODE



SC75–3 1.60x0.80x0.80, 1.00P CASE 463 ISSUE H

DATE 01 FEB 2024

RECOMMEND



SOT-1123 0.80x0.60x0.37, 0.35P CASE 524AA ISSUE D

DATE 18 JAN 2024



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THI, ASH,

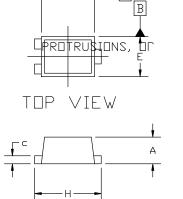
≺ GATE BURRS.

MILLIMETERS						
DIM	MIN	NDM	MAX			
А	0.34	0.37	0.40			
b	0,15	0.22	0.2			
			^ 5			
e	0.35	0.38	0,40			
Н	0.950	1.000	1.050			
L	0.185 REF					
L2	0.05	0.10	0.15			

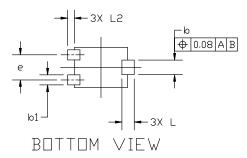
RECOMMENDED

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MOUNTING FOOTPRINT







GENERIC MARKING DIAGRAM*



X = Specific Device Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:
PIN 1. BASE	PIN 1. ANODE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. GATE
2. EMITTER	2. N/C	2. ANODE	2. CATHODE	2. SOURCE
3. COLLECTOR	CATHODE	CATHODE	ANODE	3. DRAIN

SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

DATE 24 JAN 2024

GENERIC MARKING



= Specific Device Code = Date Code ΧХ

Μ

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